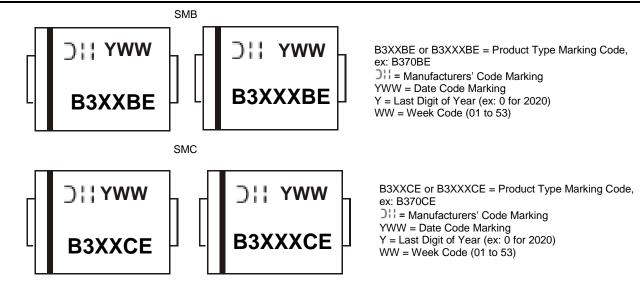


Marking Information



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic | Symbol | B370BE B370CE | B380BE B380CE | B390BE B390CE | B3100BE B3100CE | Unit |
|---|---------------------|------------------|------------------|------------------|--------------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | Vrrm Vrwm Vrm | 70 | 80 | 90 | 100 | V |
| Average Rectified Output Current | lo | 3 | | | А | |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | IFSM | 100 | | | А | |

Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|---|------------|----------|-------------|------|
| Typical Thermal Resistance Junction to Ambient (Note 6) | SMB SMC | Reja | 90 70 | °C/W |
| Typical Thermal Resistance Junction to Case (Note 6) | SMB SMC | Rejc | 50 30 | °C/W |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +150 | °C |

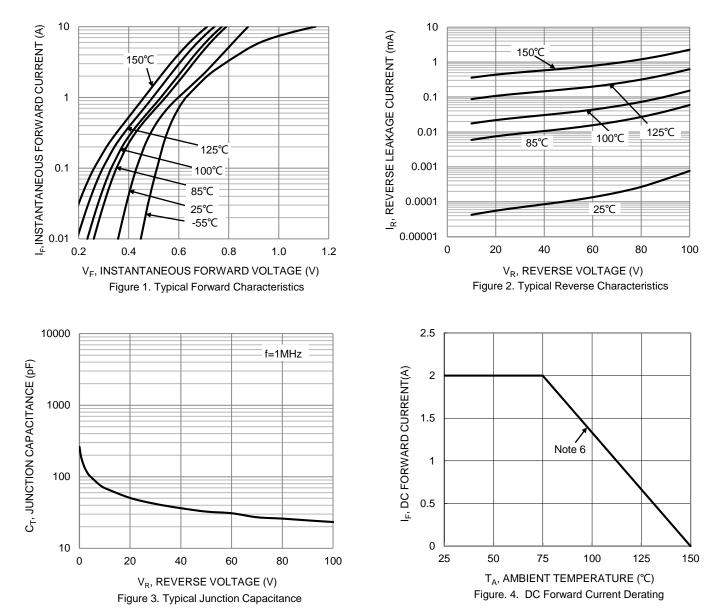
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

| Characte | eristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--------------------------|--|--------|------|--------------------|-----------------------------------|------|--|
| Forward Voltage Drop | | VF | _ | 0.74 0.60 | 0.79 — | V | $I_F = 3A, T_A = +25^{\circ}C$ $I_F = 3A, T_A = +125^{\circ}C$ |
| Leakage Current (Note 7) | B370BE/B370CE B380BE/B380CE B390BE/B390CE B3100BE/B3100CE | IR | | — — — 0.7 | 0.10 0.15 0.20 0.30 — | mA | $V_{R} = 70V, T_{A} = +25^{\circ}C$ $V_{R} = 80V, T_{A} = +25^{\circ}C$ $V_{R} = 90V, T_{A} = +25^{\circ}C$ $V_{R} = 100V, T_{A} = +25^{\circ}C$ $V_{R} = 100V, T_{A} = +125^{\circ}C$ |
| Typical Capacitance | | Ст | _ | 105 | | pF | V _R = 4.0V, f = 1MHz |

Notes: 6. Device mounted on FR-4 substrate, 1"*1", 2oz, single-sided, PC boards with 0.56"*0.73" copper pad. 7. Short duration pulse test used to minimize self-heating effect.



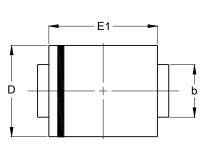
B370BE-B3100BE B370CE-B3100CE

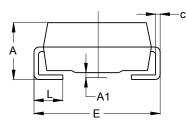




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

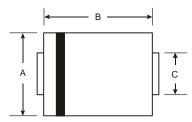


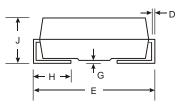


| SMB | | | | |
|----------------------|------|------|--|--|
| Dim | Min | Max | | |
| Α | 2.00 | 2.50 | | |
| A1 | 0.05 | 0.20 | | |
| b | 1.96 | 2.21 | | |
| С | 0.15 | 0.31 | | |
| D | 3.30 | 3.94 | | |
| E | 5.00 | 5.59 | | |
| E1 4.06 4.57 | | | | |
| L 0.76 1.52 | | | | |
| All Dimensions in mm | | | | |

SMC

SMB





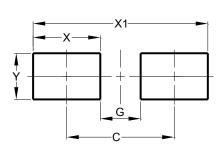
| SMC | | | | |
|----------------------|-------------|------|--|--|
| Dim | Min | Max | | |
| Α | 5.59 | 6.22 | | |
| В | 6.60 | 7.11 | | |
| С | 2.75 | 3.18 | | |
| D | 0.15 | 0.31 | | |
| E 7.75 8.13 | | | | |
| G 0.10 0.20 | | | | |
| н | H 0.76 1.52 | | | |
| J | 2.00 | 2.50 | | |
| All Dimensions in mm | | | | |

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Suggested Pad Layout

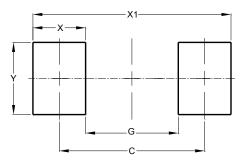
Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 4.30 |
| G | 1.80 |
| Х | 2.50 |
| X1 | 6.80 |
| Y | 2.30 |

SMC

SMB



| Dimensions | Value | | |
|------------|---------|--|--|
| | (in mm) | | |
| С | 6.90 | | |
| G | 4.40 | | |
| Х | 2.50 | | |
| X1 | 9.40 | | |
| Y | 3.30 | | |

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